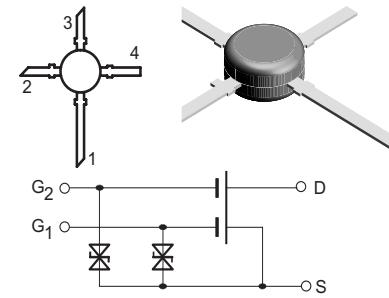


N-Channel Dual Gate MOS-Fieldeffect Tetrode, Depletion Mode

Features

- Integrated gate protection diodes
- High cross modulation performance
- Low noise figure
- High gain
- High AGC-range
- Low feedback capacitance
- Low input capacitance



 Electrostatic sensitive device.
Observe precautions for handling.

13625

Applications

Input- and mixer stages especially VHF- and UHF-tuners.

Mechanical Data

Case: TO-50 Plastic case

Weight: approx. 124 mg

Marking: BF988

Pinning:

1 = Drain, 2 = Source,

3 = Gate 1, 4 = Gate 2

Absolute Maximum Ratings

$T_{amb} = 25 \text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Drain - source voltage		V_{DS}	12	V
Drain current		I_D	30	mA
Gate 1/Gate 2 - source peak current		$\pm I_{G1/G2SM}$	10	mA
Total power dissipation	$T_{amb} \leq 60 \text{ }^{\circ}\text{C}$	P_{tot}	200	mW
Channel temperature		T_{Ch}	150	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 55 to + 150	$^{\circ}\text{C}$

Maximum Thermal Resistance

Parameter	Test condition	Symbol	Value	Unit
Channel ambient	1)	R_{thChA}	450	K/W

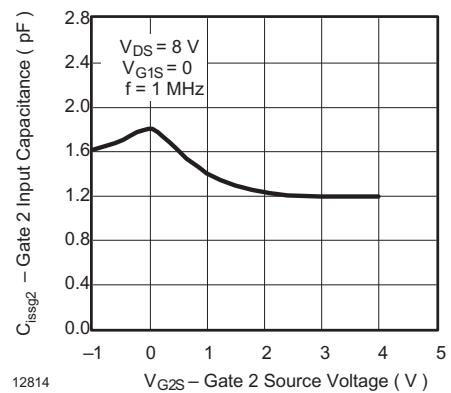
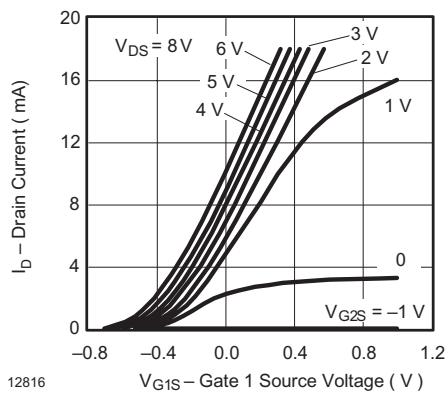
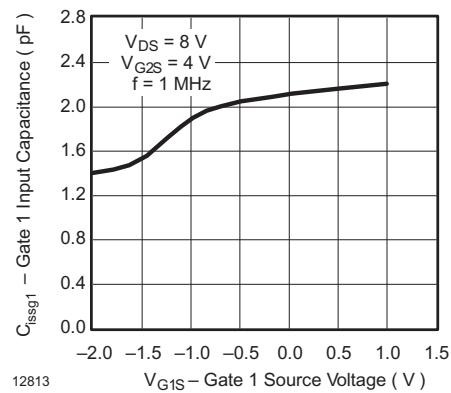
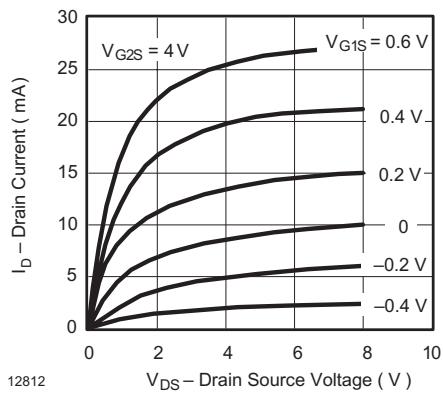
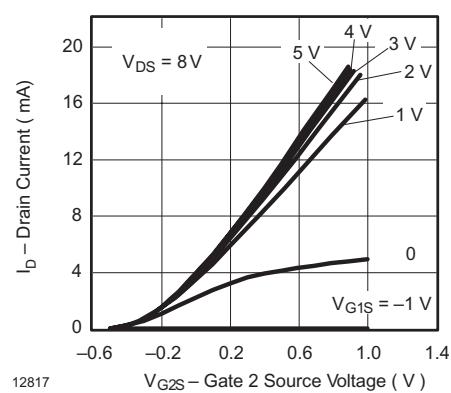
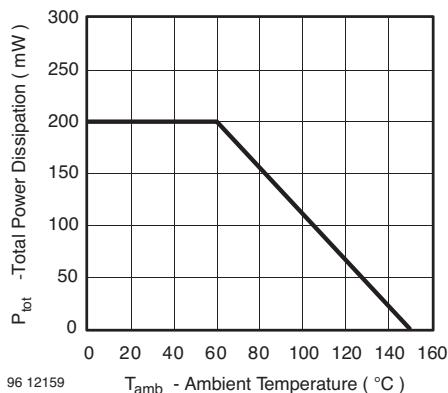
¹⁾ on glass fibre printed board (40 x 25 x 1.5) mm³ plated with 35 μm Cu

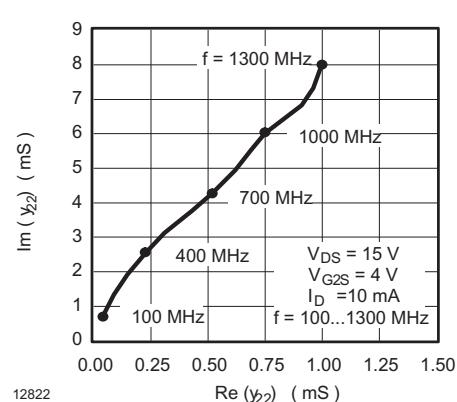
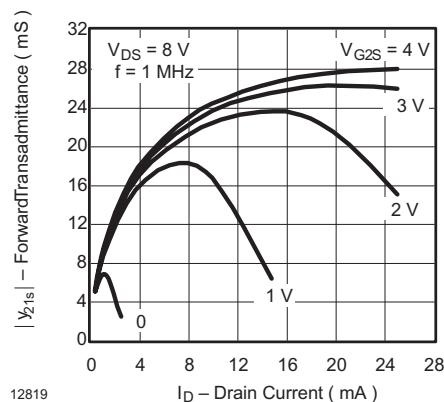
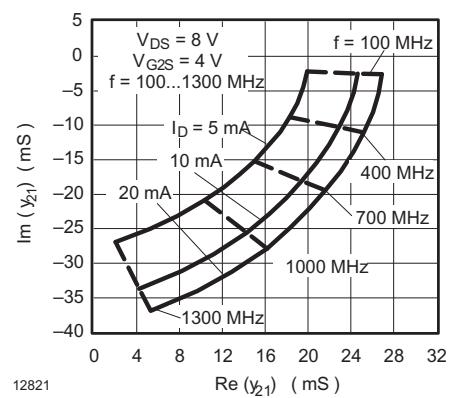
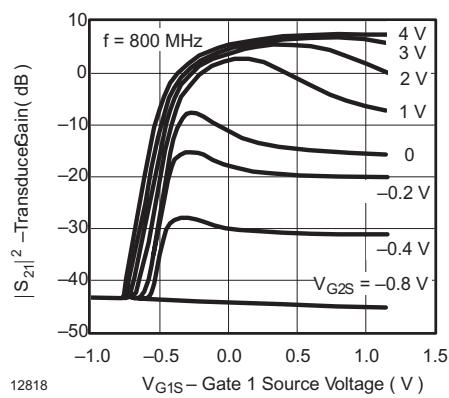
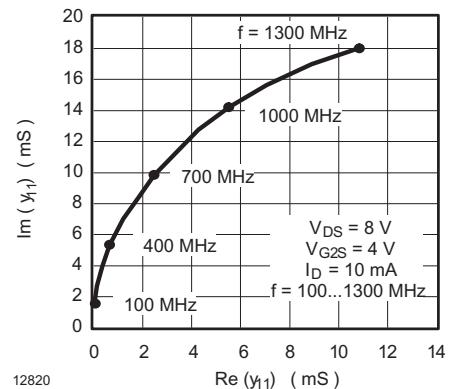
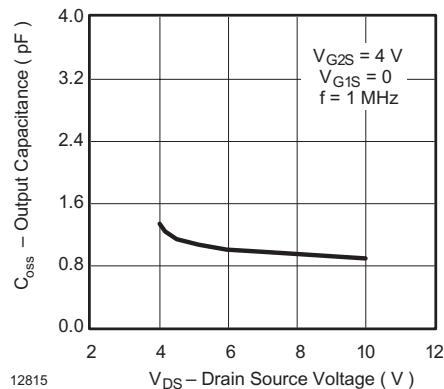
Electrical DC Characteristics $T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Drain - source breakdown voltage	$I_D = 10 \mu\text{A}, V_{G1S} = -V_{G2S} = 4 \text{ V}$		$V_{(BR)DS}$	12			V
Gate 1 - source breakdown voltage	$\pm I_{G1S} = 10 \text{ mA}, V_{G2S} = V_{DS} = 0$		$\pm V_{(BR)G1SS}$	7		14	V
Gate 2 - source breakdown voltage	$\pm I_{G2S} = 10 \text{ mA}, V_{G1S} = V_{DS} = 0$		$\pm V_{(BR)G2SS}$	7		14	V
Gate 1 - source leakage current	$\pm V_{G1S} = 5 \text{ V}, V_{G2S} = V_{DS} = 0$		$\pm I_{G1SS}$			50	nA
Gate 2 - source leakage current	$\pm V_{G2S} = 5 \text{ V}, V_{G1S} = V_{DS} = 0$		$\pm I_{G2SS}$			50	nA
Drain current	$V_{DS} = 15 \text{ V}, V_{G1S} = 0, V_{G2S} = 4 \text{ V}$	BF988	I_{DSS}	4		18	mA
		BF988A	I_{DSS}	4		10.5	mA
		BF988B	I_{DSS}	9.5		18	mA
Gate 1 - source cut-off voltage	$V_{DS} = 15 \text{ V}, V_{G2S} = 4 \text{ V}, I_D = 20 \mu\text{A}$		$-V_{G1S(OFF)}$			2.5	V
Gate 2 - source cut-off voltage	$V_{DS} = 15 \text{ V}, V_{G1S} = 0, I_D = 20 \mu\text{A}$		$-V_{G2S(OFF)}$			2.0	V

Electrical AC Characteristics $T_{amb} = 25^{\circ}\text{C}$, unless otherwise specified $V_{DS} = 8 \text{ V}, I_D = 10 \text{ mA}, V_{G2S} = 4 \text{ V}, f = 1 \text{ MHz}$

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Forward transadmittance		$ y_{21s} $	21	24		ms
Gate 1 input capacitance		C_{issg1}		2.1	2.5	pF
Gate 2 input capacitance	$V_{G1S} = 0, V_{G2S} = 4 \text{ V}$	C_{issg2}		1.2		pF
Feedback capacitance		C_{rss}		25		fF
Output capacitance		C_{oss}		1.05		pF
Power gain	$G_S = 2 \text{ mS}, G_L = 0.5 \text{ mS}, f = 200 \text{ MHz}$	G_{ps}		28		dB
	$G_S = 3.3 \text{ mS}, G_L = 1 \text{ mS}, f = 800 \text{ MHz}$	G_{ps}	16.5	20		dB
AGC range	$V_{G2S} = 4 \text{ to } -2 \text{ V}, f = 800 \text{ MHz}$	ΔG_{ps}	40			dB
Noise figure	$G_S = 2 \text{ mS}, G_L = 0.5 \text{ mS}, f = 200 \text{ MHz}$	F		1		dB
	$G_S = 3.3 \text{ mS}, G_L = 1 \text{ mS}, f = 800 \text{ MHz}$	F		1.5		dB

Typical Characteristics ($T_{amb} = 25^\circ C$ unless otherwise specified)



BF988

Vishay Semiconductors



$V_{DS} = 8 \text{ V}$, $I_D = 10 \text{ mA}$, $V_{G2S} = 4 \text{ V}$, $Z_0 = 50 \Omega$

S_{11}

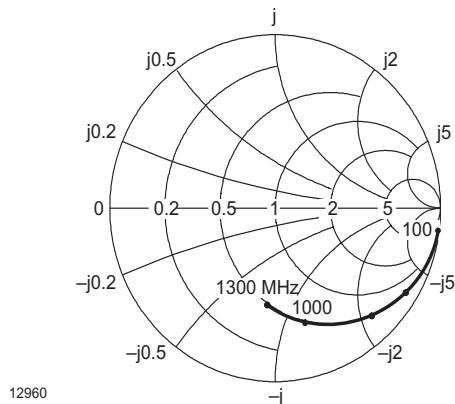


Figure 13. Input Reflection Coefficient

S_{21}

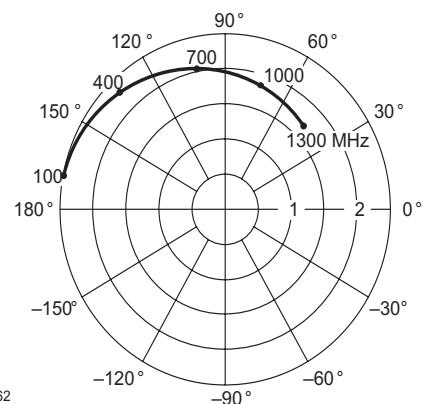


Figure 15. Forward Transmission Coefficient

S_{12}

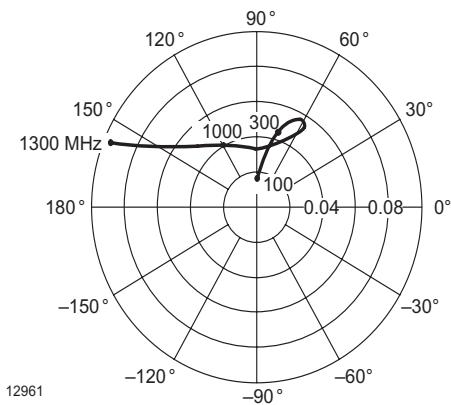


Figure 14. Reverse Transmission Coefficient

S_{22}

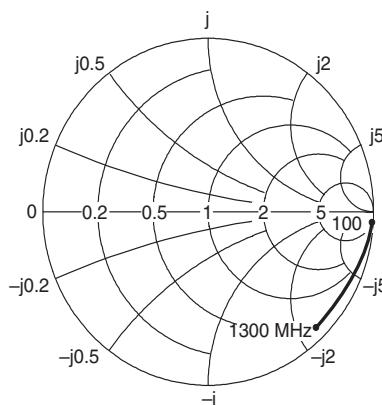
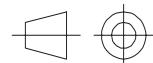
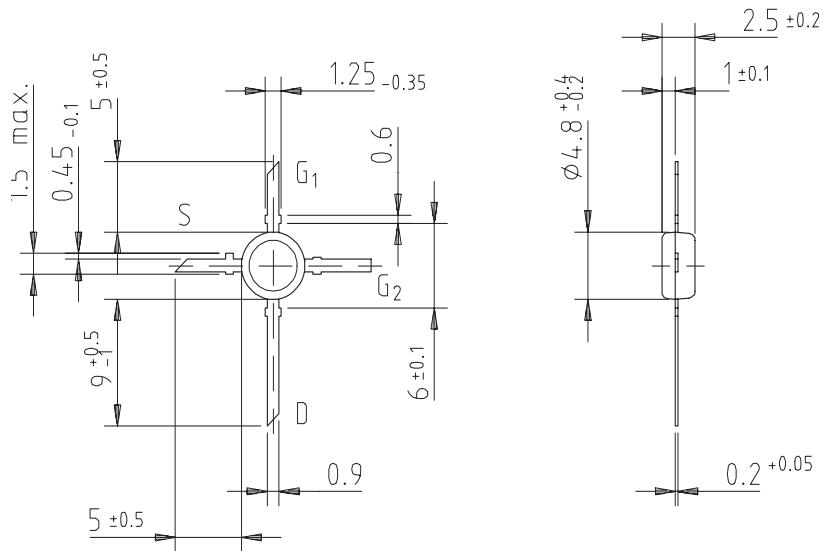


Figure 16. Output Reflection Coefficient

Package Dimensions in mm


96 12242

 technical drawings
according to DIN
specifications

Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design
and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany
Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423